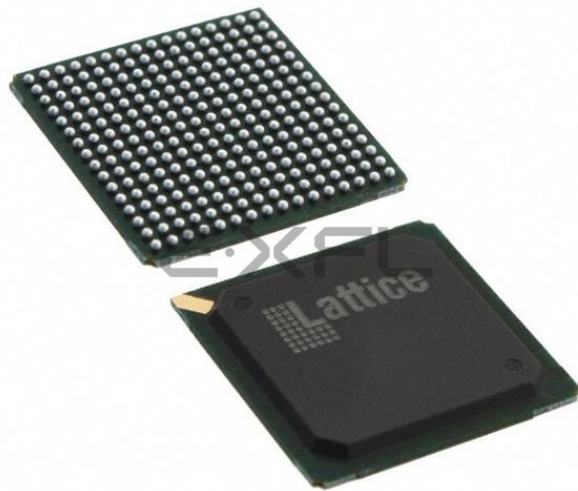




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Understanding [Embedded - FPGAs \(Field Programmable Gate Array\)](#)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details

Product Status	Active
Number of LABs/CLBs	2375
Number of Logic Elements/Cells	19000
Total RAM Bits	1246208
Number of I/O	140
Number of Gates	-
Voltage - Supply	1.14V ~ 1.26V
Mounting Type	Surface Mount
Operating Temperature	0°C ~ 85°C (TJ)
Package / Case	256-BGA
Supplier Device Package	256-FPBGA (17x17)
Purchase URL	https://www.e-xfl.com/product-detail/lattice-semiconductor/lfe2m20e-5fn256c

sysMEM Memory

LatticeECP2/M devices contains a number of sysMEM Embedded Block RAM (EBR). The EBR consists of an 18-Kbit RAM with dedicated input and output registers.

sysMEM Memory Block

The sysMEM block can implement single port, dual port or pseudo dual port memories. Each block can be used in a variety of depths and widths as shown in Table 2-6. FIFOs can be implemented in sysMEM EBR blocks by implementing support logic with PFUs. The EBR block facilitates parity checking by supporting an optional parity bit for each data byte. EBR blocks provide byte-enable support for configurations with 18-bit and 36-bit data widths.

Table 2-6. sysMEM Block Configurations

Memory Mode	Configurations
Single Port	16,384 x 1 8,192 x 2 4,096 x 4 2,048 x 9 1,024 x 18 512 x 36
True Dual Port	16,384 x 1 8,192 x 2 4,096 x 4 2,048 x 9 1,024 x 18
Pseudo Dual Port	16,384 x 1 8,192 x 2 4,096 x 4 2,048 x 9 1,024 x 18 512 x 36

Bus Size Matching

All of the multi-port memory modes support different widths on each of the ports. The RAM bits are mapped LSB word 0 to MSB word 0, LSB word 1 to MSB word 1, and so on. Although the word size and number of words for each port varies, this mapping scheme applies to each port.

RAM Initialization and ROM Operation

If desired, the contents of the RAM can be pre-loaded during device configuration. By preloading the RAM block during the chip configuration cycle and disabling the write controls, the sysMEM block can also be utilized as a ROM.

Memory Cascading

Larger and deeper blocks of RAM can be created using EBR sysMEM Blocks. Typically, the Lattice design tools cascade memory transparently, based on specific design inputs.

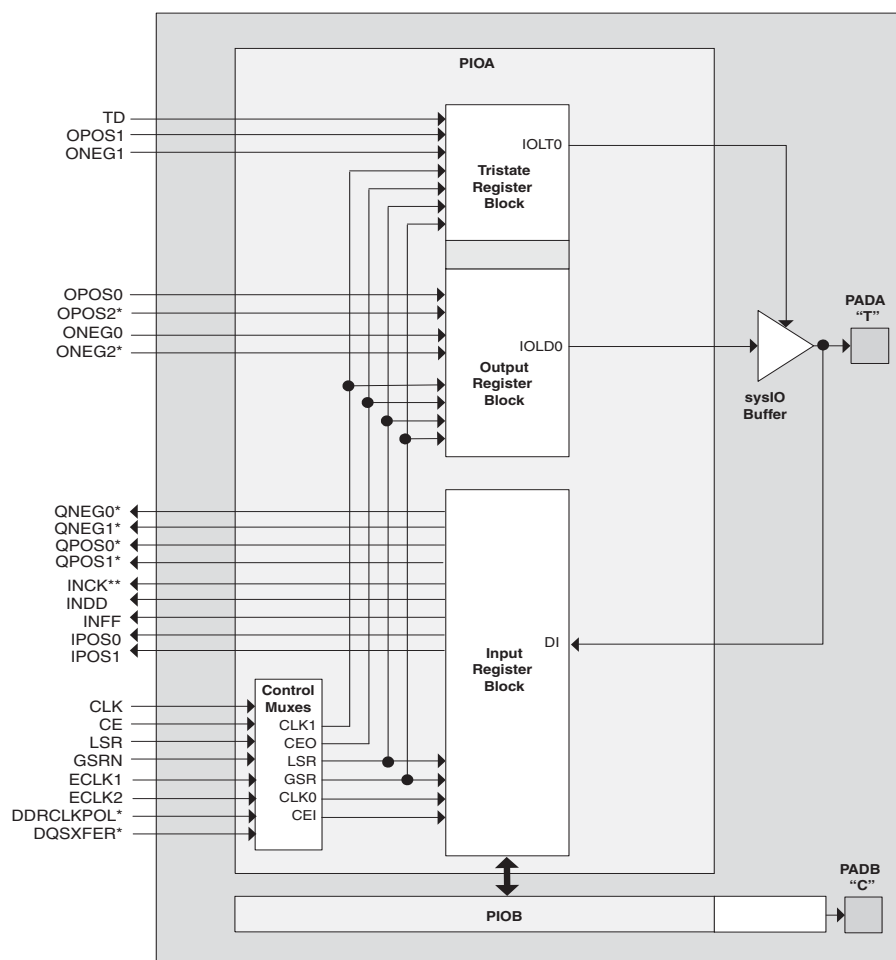
Single, Dual and Pseudo-Dual Port Modes

In all the sysMEM RAM modes the input data and address for the ports are registered at the input of the memory array. The output data of the memory is optionally registered at the output.

EBR memory supports two forms of write behavior for single port or dual port operation:

1. Normal – Data on the output appears only during a read cycle. During a write cycle, the data (at the current address) does not appear on the output. This mode is supported for all data widths.

Figure 2-28. PIC Diagram



*Signals are available on left/right/bottom edges only.
** Selected blocks.

Two adjacent PIOs can be joined to provide a differential I/O pair (labeled as "T" and "C") as shown in Figure 2-28. The PAD Labels "T" and "C" distinguish the two PIOs. Approximately 50% of the PIO pairs on the left and right edges of the device can be configured as true LVDS outputs. All I/O pairs can operate as inputs.

Table 2-12. PIO Signals List

Name	Type	Description
CE0, CE1	Control from the core	Clock enables for input and output block flip-flops
CLK0, CLK1	Control from the core	System clocks for input and output blocks
ECLK1, ECLK2	Control from the core	Fast edge clocks
LSR	Control from the core	Local Set/Reset
GSRN	Control from routing	Global Set/Reset (active low)
INCK ²	Input to the core	Input to Primary Clock Network or PLL reference inputs
DQS	Input to PIO	DQS signal from logic (routing) to PIO
INDD	Input to the core	Unregistered data input to core
INFF	Input to the core	Registered input on positive edge of the clock (CLK0)
IPOS0, IPOS1	Input to the core	Double data rate registered inputs to the core
QPOS0 ¹ , QPOS1 ¹	Input to the core	Gearbox pipelined inputs to the core
QNEG0 ¹ , QNEG1 ¹	Input to the core	Gearbox pipelined inputs to the core
OPOS0, ONEG0, OPOS2, ONEG2	Output data from the core	Output signals from the core for SDR and DDR operation
OPOS1 ONEG1	Tristate control from the core	Signals to Tristate Register block for DDR operation
DEL[3:0]	Control from the core	Dynamic input delay control bits
TD	Tristate control from the core	Tristate signal from the core used in SDR operation
DDRCLKPOL	Control from clock polarity bus	Controls the polarity of the clock (CLK0) that feed the DDR input block
DQSXFER	Control from core	Controls signal to the Output block

1. Signals available on left/right/bottom only.

2. Selected I/O.

PIO

The PIO contains four blocks: an input register block, output register block, tristate register block and a control logic block. These blocks contain registers for operating in a variety of modes along with the necessary clock and selection logic.

Input Register Block

The input register blocks for PIOs in left, right and bottom edges contain delay elements and registers that can be used to condition high-speed interface signals, such as DDR memory interfaces and source synchronous interfaces, before they are passed to the device core. Figure 2-29 shows the diagram of the input register block for left, right and bottom edges. The input register block for the top edge contains one memory element to register the input signal as shown in Figure 2-30. The following description applies to the input register block for PIOs in the left, right and bottom edges of the device.

Input signals are fed from the sysI/O buffer to the input register block (as signal DI). If desired, the input signal can bypass the register and delay elements and be used directly as a combinatorial signal (INDD), a clock (INCK) and, in selected blocks, the input to the DQS delay block. If an input delay is desired, designers can select either a fixed delay or a dynamic delay DEL[3:0]. The delay, if selected, reduces input register hold time requirements when using a global clock.

The input block allows three modes of operation. In the single data rate (SDR) the data is registered, by one of the registers in the single data rate sync register block, with the system clock. In DDR Mode, two registers are used to sample the data on the positive and negative edges of the DQS signal, creating two data streams, D0 and D1. These two data streams are synchronized with the system clock before entering the core. Further discussion on this topic is in the DDR Memory section of this data sheet.



LatticeECP2/M Family Data Sheet

DC and Switching Characteristics

September 2013

Data Sheet DS1006

Absolute Maximum Ratings^{1, 2, 3}

Supply Voltage V_{CC} -0.5 to 1.32V

Supply Voltage V_{CCAUX} -0.5 to 3.75V

Supply Voltage V_{CCJ} -0.5 to 3.75V

Output Supply Voltage V_{CCIO} -0.5 to 3.75V

Input or I/O Tristate Voltage Applied⁴ -0.5 to 3.75V

Storage Temperature (Ambient) -65 to 150°C

Junction Temperature (T_j) +125°C

1. Stress above those listed under the "Absolute Maximum Ratings" may cause permanent damage to the device. Functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied.
2. Compliance with the Lattice [Thermal Management](#) document is required.
3. All voltages referenced to GND.
4. Overshoot and undershoot of -2V to ($V_{IHMAX} + 2$) volts is permitted for a duration of <20ns.

Recommended Operating Conditions⁷

Symbol	Parameter	Min.	Max.	Units
$V_{CC}^{1, 4, 5}$	Core Supply Voltage	1.14	1.26	V
$V_{CCAUX}^{1, 3, 4, 5}$	Auxiliary Supply Voltage	3.135	3.465	V
V_{CCPLL}	PLL Supply Voltage	1.14	1.26	V
$V_{CCIO}^{1, 2, 4}$	I/O Driver Supply Voltage	1.14	3.465	V
V_{CCJ}^1	Supply Voltage for IEEE 1149.1 Test Access Port	1.14	3.465	V
t_{JCOM}	Junction Temperature, Commercial Operation	0	85	°C
t_{JIND}	Junction Temperature, Industrial Operation	-40	100	°C
SERDES External Power Supply (For LatticeECP2M Family Only)				
V_{CCIB}	Input Buffer Power Supply (1.2V)	1.14	1.26	V
	Input Buffer Power Supply (1.5V)	1.425	1.575	V
V_{CCOB}	Output Buffer Power Supply (1.2V)	1.14	1.26	V
	Output Buffer Power Supply (1.5V)	1.425	1.575	V
$V_{CCAUX33}$	Termination Resistor Switching Power Supply	3.135	3.465	V
V_{CCR}^6	Receive Power Supply	1.14	1.26	V
V_{CCT}^6	Transmit Power Supply	1.14	1.26	V

LatticeECP2 Supply Current (Standby)^{1, 2, 3, 4}
Over Recommended Operating Conditions

Symbol	Parameter	Device	Typ. ⁵	Units
I_{CC}	Core Power Supply Current	ECP2-6	10	mA
		ECP2-12	20	mA
		ECP2-20	30	mA
		ECP2-35	50	mA
		ECP2-50	70	mA
		ECP2-70	100	mA
I_{CCAUX}	Auxiliary Power Supply Current	ECP2-6	24	mA
		ECP2-12	24	mA
		ECP2-20	24	mA
		ECP2-35	24	mA
		ECP2-50	24	mA
		ECP2-70	24	mA
I_{CCGPLL}	GPLL Power Supply Current (per GPLL)	ECP2-35, -50, -70 Only	0.5	mA
I_{CCSPLL}	GPLL Power Supply Current (per SPLL)	ECP2-35, -50, -70 Only	0.5	mA
I_{CCIO}	Bank Power Supply Current (Per Bank)	ECP2-6	2	mA
		ECP2-12	2	mA
		ECP2-20	2	mA
		ECP2-35	2	mA
		ECP2-50	2	mA
		ECP2-70	2	mA
I_{CCJ}	VCCJ Power Supply Current	All Devices	3	mA

1. For further information about supply current, please see the list of additional technical documentation at the end of this data sheet.

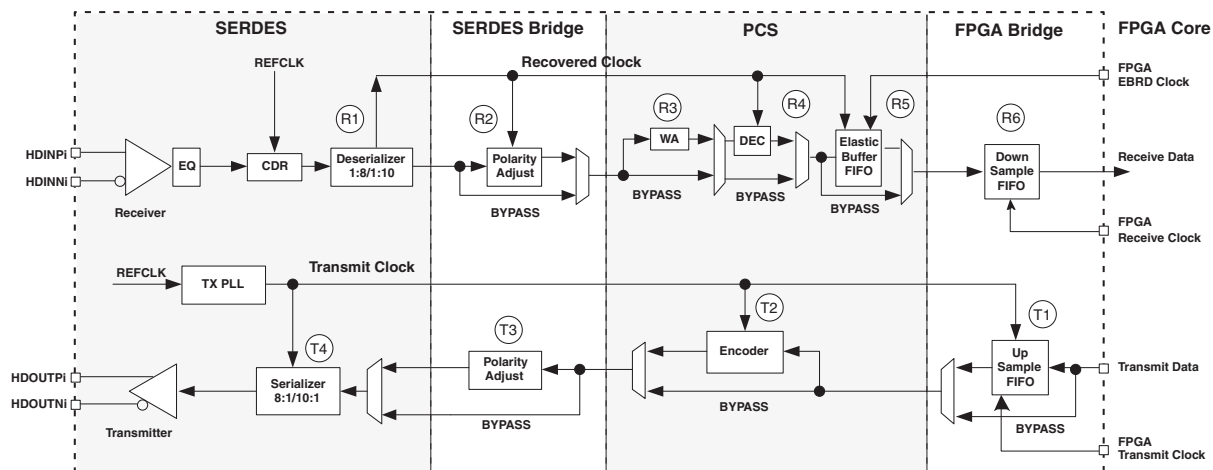
2. Assumes all outputs are tristated, all inputs are configured as LVCMOS and held at the V_{CCIO} or GND.

3. Frequency 0MHz.

4. Pattern represents a “blank” configuration data file.

5. $T_J = 25^\circ\text{C}$, power supplies at normal voltage.

Figure 3-12. Transmitter and Receiver Block Diagram



LatticeECP2M Pin Information Summary, LFE2M50, LFE2M70 and LFE2M100

Pin Type		LFE2M50			LFE2M70		LFE2M100	
		484 fpBGA	672 fpBGA	900 fpBGA	900 fpBGA	1152 fpBGA	900 fpBGA	1152 fpBGA
Single Ended User I/O		270	372	410	416	436	416	520
Differential Pair User I/O		135	185	205	208	218	207	260
Configuration	TAP Pins	5	5	5	5	5	5	5
	Muxed Pins	14	14	14	14	14	14	14
	Dedicated Pins (Non TAP)	7	7	7	7	7	7	7
Non Configuration	Muxed Pins	69	72	72	75	76	74	78
	Dedicated Pins	3	3	3	3	3	3	3
VCC		16	20	62	44	44	44	44
VCCAUX		8	26	18	16	12	16	12
VCCPLL		4	8	4	4	4	4	4
VCCIO	Bank0	4	5	6	6	7	6	7
	Bank1	3	4	6	6	7	6	7
	Bank2	4	5	9	9	9	9	9
	Bank3	4	5	9	9	9	9	9
	Bank4	4	4	6	6	7	6	7
	Bank5	4	5	6	6	7	6	7
	Bank6	4	5	9	9	9	9	9
	Bank7	4	5	9	9	9	9	9
	Bank8	2	2	2	2	2	2	2
GND, GND0 to GND7		57	80	122	122	134	122	134
NC		31	35	121	63	283	63	199
Single Ended/ Differential I/O Pairs per Bank (including emulated with resistors)	Bank0	36/18	63/31	56/28	34/17	46/23	34/17	54/27
	Bank1	18/9	18/9	36/18	42/21	34/17	42/21	44/22
	Bank2	30/15	50/25	54/27	70/35	72/36	70/35	80/40
	Bank3	36/18	43/21	44/22	60/30	64/32	60/30	80/40
	Bank4	42/21	24/12	38/19	38/19	40/20	38/19	44/22
	Bank5	28/14	60/30	58/29	40/20	40/20	40/20	46/23
	Bank6	40/20	54/27	60/30	62/31	66/33	62/31	82/41
	Bank7	40/20	60/30	64/32	70/35	74/37	70/35	90/45
	Bank8	0/0	0/0	0/0	0/0	0/0	0/0	0/0
True LVDS I/O Pairs per Bank	Bank0 (Top Edge)	0	0	0	0	0	0	0
	Bank1 (Top Edge)	0	0	0	0	0	0	0
	Bank2 (Right Edge)	7	12	13	17	18	17	20
	Bank3 (Right Edge)	9	11	11	15	16	15	20
	Bank4 (Bottom Edge)	0	0	0	0	0	0	0
	Bank5 (Bottom Edge)	0	0	0	0	0	0	0
	Bank6 (Left Edge)	10	14	15	15	16	15	20
	Bank7 (Left Edge)	10	15	17	17	18	17	22
	Bank8 (Right Edge)	0	0	0	0	0	0	0

LFE2-20E/SE Logic Signal Connections: 256 fpBGA (Cont.)

LFE2-20E/SE					
Ball Number	Ball Number	Ball/Pad Function	Bank	Dual Function	Differential
GND	GND	GNDIO5	-		
R4	R4	PB33A	5	BDQS33	T
L6	L6	PB34A	5	BDQ33	T
T4	T4	PB33B	5	BDQ33	C
L7	L7	PB34B	5	BDQ33	C
N7	N7	PB35A	5	PCLKT5_0/BDQ33	T
VCCIO	VCCIO	VCCIO5	5		
M8	M8	PB35B	5	PCLKC5_0/BDQ33	C
GND	GND	GNDIO5	-		
P7	P7	PB40A	4	PCLKT4_0/BDQ42	T
R8	R8	PB40B	4	PCLKC4_0/BDQ42	C
VCCIO	VCCIO	VCCIO4	4		
T5	T5	PB41A	4	BDQ42	T
T6	T6	PB41B	4	BDQ42	C
T8	T8	PB42A	4	BDQS42	T
GND	GND	GNDIO4	-		
R7	R7	PB43A	4	BDQ42	T
T9	T9	PB42B	4	BDQ42	C
T7	T7	PB43B	4	BDQ42	C
L8	L8	PB44A	4	BDQ42	T
VCCIO	VCCIO	VCCIO4	4		
P8	P8	PB45A	4	BDQ42	T
L9	L9	PB44B	4	BDQ42	C
N8	N8	PB45B	4	BDQ42	C
R9	R9	PB46A	4	BDQ42	T
GND	GND	GNDIO4	-		
R10	R10	PB46B	4	BDQ42	C
-	VCC	VCCIO	4		
-	GND	GNDIO4	4		
N9	N9	PB56A	4	BDQ60	T
T10	T10	PB57A	4	BDQ60	T
M9	M9	PB56B	4	BDQ60	C
R11	R11	PB57B	4	BDQ60	C
P10	P10	PB58A	4	BDQ60	T
N11	N11	PB59A	4	BDQ60	T
VCCIO	VCCIO	VCCIO4	4		
N10	N10	PB58B	4	BDQ60	C
P11	P11	PB59B	4	BDQ60	C
T11	T11	PB60A	4	BDQS60	T
GND	GND	GNDIO4	-		
M11	M11	PB61A	4	BDQ60	T
T12	T12	PB60B	4	BDQ60	C

LFE2-35E/SE and LFE2-50E/SE Logic Signal Connections: 484 fpBGA (Cont.)

LFE2-35E/SE					LFE2-50E/SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
G17	PR13B	2	RDQ14	C	PR15B	2	RDQ16	C
F19	PR13A	2	RDQ14	T	PR15A	2	RDQ16	T
E20	PR12B	2	RDQ14	C (LVDS)*	PR14B	2	RDQ16	C (LVDS)*
D20	PR12A	2	RDQ14	T (LVDS)*	PR14A	2	RDQ16	T (LVDS)*
VCCIO	VCCIO2	2			VCCIO	2		
F18	PR11B	2	RDQ14	C	PR13B	2	RDQ16	C
F16	PR11A	2	RDQ14	T	PR13A	2	RDQ16	T
C21	PR10B	2	RDQ14	C (LVDS)*	PR12B	2	RDQ16	C (LVDS)*
C22	PR10A	2	RDQ14	T (LVDS)*	PR12A	2	RDQ16	T (LVDS)*
VCCIO	VCCIO2	2			VCCIO	2		
GNDIO	GNDIO2	-			GNDIO2	-		
D19	PR2B	2	VREF2_2/RDQ6	C (LVDS)*	PR2B	2	VREF2_2	C (LVDS)*
E19	PR2A	2	VREF1_2/RDQ6	T (LVDS)*	PR2A	2	VREF1_2	T (LVDS)*
B21	PT73B	1	VREF2_1	C	PT82B	1	VREF2_1	C
GNDIO	GNDIO1	-			GNDIO1	-		
B22	PT73A	1	VREF1_1	T	PT82A	1	VREF1_1	T
C20	PT72B	1		C	PT81B	1		C
C19	PT72A	1		T	PT81A	1		T
D18	PT71B	1		C	PT80B	1		C
VCCIO	VCCIO1	1			VCCIO	1		
E18	PT71A	1		T	PT80A	1		T
B20	PT70B	1		C	PT79B	1		C
A19	PT70A	1		T	PT79A	1		T
D17	PT69B	1		C	PT78B	1		C
C18	PT69A	1		T	PT78A	1		T
A21	PT68B	1		C	PT77B	1		C
GNDIO	GNDIO1	-			GNDIO1	-		
A20	PT68A	1		T	PT77A	1		T
A18	PT67B	1		C	PT76B	1		C
VCCIO	VCCIO1	1			VCCIO	1		
B18	PT67A	1		T	PT76A	1		T
G16	PT66B	1		C	PT75B	1		C
G15	PT66A	1		T	PT75A	1		T
D16	PT65B	1		C	PT74B	1		C
E16	PT65A	1		T	PT74A	1		T
GNDIO	GNDIO1	-			GNDIO1	-		
VCCIO	VCCIO1	1			VCCIO	1		
C17	PT55B	1		C	PT64B	1		C
GNDIO	GNDIO1	-			GNDIO1	-		
C16	PT55A	1		T	PT64A	1		T
B17	PT54B	1		C	PT63B	1		C
B16	PT54A	1		T	PT63A	1		T
A17	PT53B	1		C	PT62B	1		C
VCCIO	VCCIO1	1			VCCIO	1		
A16	PT53A	1		T	PT62A	1		T
C15	PT52B	1		C	PT61B	1		C

LFE2-20E/SE and LFE2-35E/SE Logic Signal Connections: 672 fpBGA (Cont.)

LFE2-20E/20SE					LFE2-35E/35SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
GND	GNDIO2	-			GNDIO2	-		
L21	PR18B	2	RDQ16	C (LVDS)*	PR24B	2	RDQ22	C (LVDS)*
K22	PR18A	2	RDQ16	T (LVDS)*	PR24A	2	RDQ22	T (LVDS)*
M24	PR17B	2	RDQ16	C	PR23B	2	RDQ22	C
N23	PR17A	2	RDQ16	T	PR23A	2	RDQ22	T
VCCIO	VCCIO2	2			VCCIO2	2		
K26	PR16B	2	RDQ16	C (LVDS)*	PR22B	2	RDQ22	C (LVDS)*
K25	PR16A	2	RDQS16	T (LVDS)*	PR22A	2	RDQS22	T (LVDS)*
M20	PR15B	2	RDQ16	C	PR21B	2	RDQ22	C
GND	GNDIO2	-			GNDIO2	-		
M19	PR15A	2	RDQ16	T	PR21A	2	RDQ22	T
L22	PR14B	2	RDQ16	C (LVDS)*	PR20B	2	RDQ22	C (LVDS)*
M22	PR14A	2	RDQ16	T (LVDS)*	PR20A	2	RDQ22	T (LVDS)*
K21	PR13B	2	RDQ16	C	PR19B	2	RDQ22	C
VCCIO	VCCIO2	2			VCCIO2	2		
M21	PR13A	2	RDQ16	T	PR19A	2	RDQ22	T
K24	PR12B	2	RDQ16	C (LVDS)*	PR18B	2	RDQ22	C (LVDS)*
J24	PR12A	2	RDQ16	T (LVDS)*	PR18A	2	RDQ22	T (LVDS)*
GND	GNDIO2	-			GNDIO2	-		
VCCIO	VCCIO2	2			VCCIO2	2		
L20	VCC	-			NC	-		
GND	GNDIO2	-			GNDIO2	-		
J26	NC	-			NC	-		
J25	NC	-			NC	-		
J23	NC	-			NC	-		
K23	NC	-			NC	-		
VCCIO	VCCIO2	2			VCCIO2	2		
H26	NC	-			NC	-		
H25	NC	-			NC	-		
H24	NC	-			NC	-		
GND	GNDIO2	-			GNDIO2	-		
H23	NC	-			NC	-		
VCCIO	VCCIO2	2			VCCIO2	2		
G26	PR11B	2	RDQ8	C	PR17B	2	RDQ14	C
GND	GNDIO2	-			GNDIO2	-		
G25	PR11A	2	RDQ8	T	PR17A	2	RDQ14	T
F26	PR10B	2	RDQ8	C (LVDS)*	PR16B	2	RDQ14	C (LVDS)*
F25	PR10A	2	RDQ8	T (LVDS)*	PR16A	2	RDQ14	T (LVDS)*
K20	PR9B	2	RDQ8	C	PR15B	2	RDQ14	C
VCCIO	VCCIO2	2			VCCIO2	2		
L19	PR9A	2	RDQ8	T	PR15A	2	RDQ14	T
E26	PR8B	2	RDQ8	C (LVDS)*	PR14B	2	RDQ14	C (LVDS)*
E25	PR8A	2	RDQS8	T (LVDS)*	PR14A	2	RDQS14	T (LVDS)*
GND	GNDIO2	-			GNDIO2	-		
J22	PR7B	2	RDQ8	C	PR13B	2	RDQ14	C
H22	PR7A	2	RDQ8	T	PR13A	2	RDQ14	T

LFE2-50E/SE and LFE2-70E/SE Logic Signal Connections: 672 fpBGA (Cont.)

LFE2-50E/SE					LFE2-70E/SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
Y21	PB82A	4	VREF2_4/BDQ78	T	PB100A	4	VREF2_4/BDQ96	T
AB23	PB82B	4	VREF1_4/BDQ78	C	PB100B	4	VREF1_4/BDQ96	C
GND	GNDIO4	-			GNDIO4	-		
AD24	CFG2	8			CFG2	8		
W20	CFG1	8			CFG1	8		
AC24	CFG0	8			CFG0	8		
V19	PROGRAMN	8			PROGRAMN	8		
AA22	CCLK	8			CCLK	8		
AB24	INITN	8			INITN	8		
AD25	DONE	8			DONE	8		
GND	GNDIO8	-			GNDIO8	-		
W21	PR77B	8	WRITEN	C	PR90B	8	WRITEN	C
Y22	PR77A	8	CS1N	T	PR90A	8	CS1N	T
AC25	PR76B	8	CSN	C	PR89B	8	CSN	C
AB25	PR76A	8	D0/SPIFASTN	T	PR89A	8	D0/SPIFASTN	T
VCCIO	VCCIO8	8			VCCIO8	8		
AD26	PR75B	8	D1	C	PR88B	8	D1	C
AC26	PR75A	8	D2	T	PR88A	8	D2	T
Y23	PR74B	8	D3	C	PR87B	8	D3	C
GND	GNDIO8	-			GNDIO8	-		
W22	PR74A	8	D4	T	PR87A	8	D4	T
AA25	PR73B	8	D5	C	PR86B	8	D5	C
AB26	PR73A	8	D6	T	PR86A	8	D6	T
W23	PR72B	8	D7/SPID0	C	PR85B	8	D7/SPID0	C
VCCIO	VCCIO8	8			VCCIO8	8		
V22	PR72A	8	DI/CSSPI0N	T	PR85A	8	DI/CSSPI0N	T
Y24	PR71B	8	DOUT/CSON	C	PR84B	8	DOUT/CSON	C
Y25	PR71A	8	BUSY/SISPI	T	PR84A	8	BUSY/SISPI	T
W24	PR70B	3	RDQ67	C	PR83B	3	RDQ80	C
GND	GNDIO3	-			GNDIO3	-		
V23	PR70A	3	RDQ67	T	PR83A	3	RDQ80	T
AA26	PR69B	3	RDQ67	C (LVDS)*	PR82B	3	RDQ80	C (LVDS)*
Y26	PR69A	3	RDQ67	T (LVDS)*	PR82A	3	RDQ80	T (LVDS)*
U21	PR68B	3	RDQ67	C	PR81B	3	RDQ80	C
VCCIO	VCCIO3	3			VCCIO3	3		
U19	PR68A	3	RDQ67	T	PR81A	3	RDQ80	T
W25	PR67B	3	RDQ67	C (LVDS)*	PR80B	3	RDQ80	C (LVDS)*
W26	PR67A	3	RDQS67	T (LVDS)*	PR80A	3	RDQS80	T (LVDS)*
GND	GNDIO3	-			GNDIO3	-		
V24	PR66B	3	RDQ67	C	PR79B	3	RDQ80	C
V25	PR66A	3	RDQ67	T	PR79A	3	RDQ80	T
V26	PR65B	3	RDQ67	C (LVDS)*	PR78B	3	RDQ80	C (LVDS)*
U26	PR65A	3	RDQ67	T (LVDS)*	PR78A	3	RDQ80	T (LVDS)*
VCCIO	VCCIO3	3			VCCIO3	3		
U22	PR64B	3	RLM0_GPLL_C_FB_A/RDQ67	C	PR77B	3	RLM0_GPLL_C_FB_A/RDQ80	C
U23	PR64A	3	RLM0_GPLL_T_FB_A/RDQ67	T	PR77A	3	RLM0_GPLL_T_FB_A/RDQ80	T

LFE2-70E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2-70E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential
P3	PL54B	7	LDQ54	C (LVDS)*
R6	PL55A	7	LDQ54	T
VCCIO	VCCIO7	7		
R8	PL55B	7	LDQ54	C
P2	PL56A	7	LDQ54	T (LVDS)*
P1	PL56B	7	LDQ54	C (LVDS)*
R5	PL57A	7	PCLKT7_0/LDQ54	T
GND	GNDIO7	-		
R7	PL57B	7	PCLKC7_0/LDQ54	C
R4	PL59A	6	PCLKT6_0/LDQ63	T (LVDS)*
R3	PL59B	6	PCLKC6_0/LDQ63	C (LVDS)*
T5	PL60A	6	VREF2_6/LDQ63	T
T7	PL60B	6	VREF1_6/LDQ63	C
T3	PL61A	6	LDQ63	T (LVDS)*
VCCIO	VCCIO6	6		
T4	PL61B	6	LDQ63	C (LVDS)*
T6	PL62A	6	LDQ63	T
T8	PL62B	6	LDQ63	C
T2	PL63A	6	LDQS63	T (LVDS)*
GND	GNDIO6	-		
T1	PL63B	6	LDQ63	C (LVDS)*
U7	PL64A	6	LDQ63	T
U5	PL64B	6	LDQ63	C
VCCIO	VCCIO6	6		
U4	PL65A	6	LDQ63	T (LVDS)*
U3	PL65B	6	LDQ63	C (LVDS)*
U8	PL66A	6	LDQ63	T
U6	PL66B	6	LDQ63	C
GND	GNDIO6	-		
U2	PL67A	6	LDQ71	T (LVDS)*
U1	PL67B	6	LDQ71	C (LVDS)*
V7	PL68A	6	LDQ71	T
V5	PL68B	6	LDQ71	C
VCCIO	VCCIO6	6		
V2	PL69A	6	LDQ71	T (LVDS)*
V1	PL69B	6	LDQ71	C (LVDS)*
V8	PL70A	6	LDQ71	T
V6	PL70B	6	LDQ71	C
GND	GNDIO6	-		
W1	PL71A	6	LDQS71	T (LVDS)*
W2	PL71B	6	LDQ71	C (LVDS)*
W5	PL72A	6	LDQ71	T
VCCIO	VCCIO6	6		

LFE2M35E/SE and LFE2M50E/SE Logic Signal Connections: 672 fpBGA (Cont.)

LFE2M35E/SE					LFE2M50E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential	
U9	PL67B	6	LDQ66	C	PL72B	6	LDQ71	C	
AA5	PL68A	6	LDQ66	T (LVDS)*	PL73A	6	LDQ71	T*	
AA6	PL68B	6	LDQ66	C (LVDS)*	PL73B	6	LDQ71	C*	
Y7	PL69A	6	LDQ66	T	PL74A	6	LDQ71	T	
GNDIO	GNDIO6	-			GNDIO6	-			
V9	PL69B	6	LDQ66	C	PL74B	6	LDQ71	C	
AC3	TCK	-			TCK	-			
W8	TDI	-			TDI	-			
AC4	TMS	-			TMS	-			
V8	TDO	-			TDO	-			
AA7	VCCJ	-			VCCJ	-			
AB6	PB2A	5	BDQ6	T	PB2A	5	BDQ6	T	
Y8	PB2B	5	BDQ6	C	PB2B	5	BDQ6	C	
AD1	PB3A	5	BDQ6	T	PB3A	5	BDQ6	T	
AD2	PB3B	5	BDQ6	C	PB3B	5	BDQ6	C	
AC5	PB4A	5	BDQ6	T	PB4A	5	BDQ6	T	
AA8	PB4B	5	BDQ6	C	PB4B	5	BDQ6	C	
VCCIO	VCCIO5	5			VCCIO5	5			
AC6	PB5A	5	BDQ6	T	PB5A	5	BDQ6	T	
W9	PB5B	5	BDQ6	C	PB5B	5	BDQ6	C	
AB7	PB6A	5	BDQS6	T	PB6A	5	BDQS6	T	
GNDIO	GNDIO5	-			GNDIO5	-			
Y9	PB6B	5	BDQ6	C	PB6B	5	BDQ6	C	
AD3	PB7A	5	BDQ6	T	PB7A	5	BDQ6	T	
AD4	PB7B	5	BDQ6	C	PB7B	5	BDQ6	C	
AA9	PB8A	5	BDQ6	T	PB8A	5	BDQ6	T	
W10	PB8B	5	BDQ6	C	PB8B	5	BDQ6	C	
VCCIO	VCCIO5	5			VCCIO5	5			
AC7	PB9A	5	BDQ6	T	PB9A	5	BDQ6	T	
Y10	PB9B	5	BDQ6	C	PB9B	5	BDQ6	C	
AE2	PB10A	5	BDQ6	T	PB10A	5	BDQ6	T	
AD5	PB10B	5	BDQ6	C	PB10B	5	BDQ6	C	
GNDIO	GNDIO5	-			GNDIO5	-			
AE4	PB11A	5	BDQ15	T	PB11A	5	BDQ15	T	
AE3	PB11B	5	BDQ15	C	PB11B	5	BDQ15	C	
W11	PB12A	5	BDQ15	T	PB12A	5	BDQ15	T	
AB8	PB12B	5	BDQ15	C	PB12B	5	BDQ15	C	
AE5	PB13A	5	BDQ15	T	PB13A	5	BDQ15	T	
AD6	PB13B	5	BDQ15	C	PB13B	5	BDQ15	C	
VCCIO	VCCIO5	5			VCCIO5	5			
AA10	PB14A	5	BDQ15	T	PB14A	5	BDQ15	T	
AC8	PB14B	5	BDQ15	C	PB14B	5	BDQ15	C	
W12	PB15A	5	BDQS15	T	PB15A	5	BDQS15	T	
GNDIO	GNDIO5	-			GNDIO5	-			
AC9	PB15B	5	BDQ15	C	PB15B	5	BDQ15	C	
W13	PB16A	5	BDQ15	T	PB16A	5	BDQ15	T	
AB10	PB16B	5	BDQ15	C	PB16B	5	BDQ15	C	
AF3	PB17A	5	BDQ15	T	PB17A	5	BDQ15	T	

LFE2M35E/SE and LFE2M50E/SE Logic Signal Connections: 672 fpBGA (Cont.)

LFE2M35E/SE					LFE2M50E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential	
C6	PT12B	0		C	PT12B	0		C	
F10	PT12A	0		T	PT12A	0		T	
D7	PT11B	0		C	PT11B	0		C	
H11	PT11A	0		T	PT11A	0		T	
D5	PT10B	0		C	PT10B	0		C	
GNDIO	GNDIO0	-			GNDIO0	-			
E6	PT10A	0		T	PT10A	0		T	
G10	PT9B	0		C	PT9B	0		C	
F9	PT9A	0		T	PT9A	0		T	
H10	PT8B	0		C	PT8B	0		C	
VCCIO	VCCIO0	0			VCCIO0	0			
E7	PT8A	0		T	PT8A	0		T	
B3	PT7B	0		C	PT7B	0		C	
C5	PT7A	0		T	PT7A	0		T	
B2	PT6B	0		C	PT6B	0		C	
C4	PT6A	0		T	PT6A	0		T	
G9	PT5B	0		C	PT5B	0		C	
GNDIO	GNDIO0	-			GNDIO0	-			
F7	PT5A	0		T	PT5A	0		T	
C3	PT4B	0		C	PT4B	0		C	
VCCIO	VCCIO0	0			VCCIO0	0			
D4	PT4A	0		T	PT4A	0		T	
J10	PT3B	0		C	PT3B	0		C	
F8	PT3A	0		T	PT3A	0		T	
G8	PT2B	0		C	PT2B	0		C	
G7	PT2A	0		T	PT2A	0		T	
L12	VCC	-			VCC	-			
L13	VCC	-			VCC	-			
L14	VCC	-			VCC	-			
L15	VCC	-			VCC	-			
M11	VCC	-			VCC	-			
M12	VCC	-			VCC	-			
M15	VCC	-			VCC	-			
M16	VCC	-			VCC	-			
N11	VCC	-			VCC	-			
N16	VCC	-			VCC	-			
P11	VCC	-			VCC	-			
P16	VCC	-			VCC	-			
R11	VCC	-			VCC	-			
R12	VCC	-			VCC	-			
R15	VCC	-			VCC	-			
R16	VCC	-			VCC	-			
T12	VCC	-			VCC	-			
T13	VCC	-			VCC	-			
T14	VCC	-			VCC	-			
T15	VCC	-			VCC	-			
B12	VCCIO0	0			VCCIO0	0			
B7	VCCIO0	0			VCCIO0	0			

LFE2M50E/SE and LFE2M70E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2M50E/SE					LFE2M70E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential	
Y22	PR60B	3		C	PR81B	3	RDQ82	C	
Y23	PR60A	3		T	PR81A	3	RDQ82	T	
AB26	NC	-			PR80B	3	RDQ82	C (LVDS)*	
AB27	NC	-			PR80A	3	RDQ82	T (LVDS)*	
-	-	-			VCCIO3	3			
Y24	NC	-			PR79B	3	RDQ82	C	
Y25	NC	-			PR79A	3	RDQ82	T	
AA29	NC	-			PR78B	3	RDQ82	C (LVDS)*	
Y28	NC	-			PR78A	3	RDQ82	T (LVDS)*	
Y30	NC	-			PR76B	3	RDQ73	C	
Y29	NC	-			PR76A	3	RDQ73	T	
-	-	-			GNDIO3	-			
-	-	-			-	-			
W22	NC	-			PR75B	3	RDQ73	C (LVDS)*	
V22	NC	-			PR75A	3	RDQ73	T (LVDS)*	
Y27	NC	-			PR74B	3	RDQ73	C	
-	-	-			VCCIO3	3			
Y26	NC	-			PR74A	3	RDQ73	T	
W30	NC	-			PR73B	3	RDQ73	C (LVDS)*	
W29	NC	-			PR73A	3	RDQS73	T (LVDS)*	
-	-	-			GNDIO3	-			
W25	NC	-			PR72B	3	RDQ73	C	
W26	NC	-			PR72A	3	RDQ73	T	
U29	PR59B	3		C (LVDS)*	PR71B	3	RDQ73	C (LVDS)*	
V29	PR59A	3		T (LVDS)*	PR71A	3	RDQ73	T (LVDS)*	
VCCIO	VCCIO3	3			VCCIO3	3			
V30	PR58B	3		C	PR70B	3	RDQ73	C	
U30	PR58A	3		T	PR70A	3	RDQ73	T	
W27	PR57B	3		C (LVDS)*	PR69B	3	RDQ73	C (LVDS)*	
W28	PR57A	3		T (LVDS)*	PR69A	3	RDQ73	T (LVDS)*	
V24	PR55B	3	RDQ52	C	PR67B	3	RDQ64	C	
V25	PR55A	3	RDQ52	T	PR67A	3	RDQ64	T	
GNDIO	GNDIO3	-			GNDIO3	-			
U28	PR54B	3	RDQ52	C (LVDS)*	PR66B	3	RDQ64	C (LVDS)*	
U27	PR54A	3	RDQ52	T (LVDS)*	PR66A	3	RDQ64	T (LVDS)*	
U23	PR53B	3	RDQ52	C	PR65B	3	RDQ64	C	
V23	PR53A	3	RDQ52	T	PR65A	3	RDQ64	T	
VCCIO	VCCIO3	3			VCCIO3	3			
V26	PR52B	3	RDQ52	C (LVDS)*	PR64B	3	RDQ64	C (LVDS)*	
U26	PR52A	3	RDQS52	T (LVDS)*	PR64A	3	RDQS64	T (LVDS)*	
U25	PR51B	3	RDQ52	C	PR63B	3	RDQ64	C	
GNDIO	GNDIO3	-			GNDIO3	-			
U24	PR51A	3	RDQ52	T	PR63A	3	RDQ64	T	
T30	PR50B	3	RDQ52	C (LVDS)*	PR62B	3	RDQ64	C (LVDS)*	
R30	PR50A	3	RDQ52	T (LVDS)*	PR62A	3	RDQ64	T (LVDS)*	
T23	PR49B	3	RDQ52	C	PR61B	3	RDQ64	C	
VCCIO	VCCIO3	3			VCCIO3	3			
T22	PR49A	3	RDQ52	T	PR61A	3	RDQ64	T	

LFE2M50E/SE and LFE2M70E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2M50E/SE					LFE2M70E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential	
J16	PT51B	1		C	PT60B	1		C	
G15	PT51A	1		T	PT60A	1		T	
GNDIO	GNDIO1	-			GNDIO1	-			
C16	PT50B	1		C	PT59B	1		C	
D16	PT50A	1		T	PT59A	1		T	
J15	PT49B	1		C	PT58B	1		C	
H15	PT49A	1		T	PT58A	1		T	
VCCIO	VCCIO1	1			VCCIO1	1			
A15	PT48B	1	VREF2_1	C	PT57B	1	VREF2_1	C	
B15	PT48A	1	VREF1_1	T	PT57A	1	VREF1_1	T	
F15	PT47B	1	PCLKC1_0	C	PT56B	1	PCLKC1_0	C	
E16	PT47A	1	PCLKT1_0	T	PT56A	1	PCLKT1_0	T	
C15	PT46B	0	PCLKC0_0	C	PT55B	0	PCLKC0_0	C	
GNDIO	GNDIO0	-			GNDIO0	-			
D15	PT46A	0	PCLKT0_0	T	PT55A	0	PCLKT0_0	T	
C14	PT45B	0	VREF2_0	C	PT54B	0	VREF2_0	C	
E15	PT45A	0	VREF1_0	T	PT54A	0	VREF1_0	T	
G14	PT44B	0		C	PT53B	0		C	
VCCIO	VCCIO0	0			VCCIO0	0			
J14	PT44A	0		T	PT53A	0		T	
F14	PT43B	0		C	PT52B	0		C	
H14	PT43A	0		T	PT52A	0		T	
A14	PT42B	0		C	PT51B	0		C	
B14	PT42A	0		T	PT51A	0		T	
D13	PT41B	0		C	PT50B	0		C	
GNDIO	GNDIO0	-			GNDIO0	-			
F13	PT41A	0		T	PT50A	0		T	
G13	PT40B	0		C	PT49B	0		C	
VCCIO	VCCIO0	0			VCCIO0	0			
J11	PT40A	0		T	PT49A	0		T	
D4	PT38B	0		C	PT47B	0		C	
D5	PT38A	0		T	PT47A	0		T	
E5	PT37B	0		C	PT46B	0		C	
F6	PT37A	0		T	PT46A	0		T	
GNDIO	GNDIO0	-			GNDIO0	-			
VCCIO	VCCIO0	0			VCCIO0	0			
F7	PT34B	0		C	PT43B	0		C	
D8	PT34A	0		T	PT43A	0		T	
GNDIO	GNDIO0	-			GNDIO0	-			
J13	PT32B	0		C	PT41B	0		C	
G11	PT32A	0		T	PT41A	0		T	
H13	PT31B	0		C	PT40B	0		C	
H12	PT31A	0		T	PT40A	0		T	
VCCIO	VCCIO0	0			VCCIO0	0			
E8	PT30B	0		C	PT39B	0		C	
D9	PT30A	0		T	PT39A	0		T	
D12	PT28B	0		C	PT37B	0		C	
GNDIO	GNDIO0	-			GNDIO0	-			

LFE2M70E/SE and LFE2M100E/SE Logic Signal Connections: 1152 fpBGA (Cont.)

LFE2M70E/SE				LFE2M100E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
AK20	PB66B	4	BDQ69	C	PB75B	4	BDQ78	C
AN22	PB67A	4	BDQ69	T	PB76A	4	BDQ78	T
AL21	PB67B	4	BDQ69	C	PB76B	4	BDQ78	C
VCCIO	VCCIO4	4			VCCIO4	4		
GNDIO	GNDIO4	-			GNDIO4	-		
AH19	PB69A	4	BDQS69	T	PB78A	4	BDQS78	T
AJ20	PB69B	4	BDQ69	C	PB78B	4	BDQ78	C
AD20	PB71A	4	BDQ69	T	PB80A	4	BDQ78	T
AF20	PB71B	4	BDQ69	C	PB80B	4	BDQ78	C
VCCIO	VCCIO4	4			VCCIO4	4		
AJ19	PB72A	4	BDQ69	T	PB81A	4	BDQ78	T
AH20	PB72B	4	BDQ69	C	PB81B	4	BDQ78	C
AE20	PB73A	4	BDQ69	T	PB82A	4	BDQ78	T
AG20	PB73B	4	BDQ69	C	PB82B	4	BDQ78	C
GNDIO	GNDIO4	-			GNDIO4	-		
AH22	NC	-			PB89A	4	BDQ87	T
-	-	-			VCCIO4	4		
AH21	NC	-			PB89B	4	BDQ87	C
AG22	NC	-			PB90A	4	BDQ87	T
AG21	NC	-			PB90B	4	BDQ87	C
-	-	-			GNDIO4	-		
AM22	PB74A	4	BDQ78	T	PB92A	4	BDQ96	T
AL22	PB74B	4	BDQ78	C	PB92B	4	BDQ96	C
VCCIO	VCCIO4	4			VCCIO4	4		
AP23	PB77A	4	BDQ78	T	PB95A	4	BDQ96	T
AN23	PB77B	4	BDQ78	C	PB95B	4	BDQ96	C
GNDIO	GNDIO4	-			GNDIO4	-		
AM24	PB78A	4	BDQS78	T	PB96A	4	BDQS96	T
AL24	PB78B	4	BDQ78	C	PB96B	4	BDQ96	C
AK22	PB79A	4	BDQ78	T	PB97A	4	BDQ96	T
AJ22	PB79B	4	BDQ78	C	PB97B	4	BDQ96	C
AL23	PB80A	4	BDQ78	T	PB98A	4	BDQ96	T
AK23	PB80B	4	BDQ78	C	PB98B	4	BDQ96	C
VCCIO	VCCIO4	4			VCCIO4	4		
AJ23	PB81A	4	BDQ78	T	PB99A	4	BDQ96	T
AH23	PB81B	4	BDQ78	C	PB99B	4	BDQ96	C
GNDIO	GNDIO4	-			GNDIO4	-		
AL28	LRC_SQ_VCCRX3	13			LRC_SQ_VCCRX3	13		
AM26	LRC_SQ_HDINP3	13		T	LRC_SQ_HDINP3	13		T
AN26	LRC_SQ_VCCIB3	13			LRC_SQ_VCCIB3	13		
AM27	LRC_SQ_HDINN3	13		C	LRC_SQ_HDINN3	13		C
AN27	LRC_SQ_VCCTX3	13			LRC_SQ_VCCTX3	13		
AP26	LRC_SQ_HDOUTP3	13		T	LRC_SQ_HDOUTP3	13		T
AL26	LRC_SQ_VCCOB3	13			LRC_SQ_VCCOB3	13		
AP27	LRC_SQ_HDOUTN3	13		C	LRC_SQ_HDOUTN3	13		C
AN28	LRC_SQ_VCCTX2	13			LRC_SQ_VCCTX2	13		
AP28	LRC_SQ_HDOUTN2	13		C	LRC_SQ_HDOUTN2	13		C
AK28	LRC_SQ_VCCOB2	13			LRC_SQ_VCCOB2	13		
AP29	LRC_SQ_HDOUTP2	13		T	LRC_SQ_HDOUTP2	13		T

Industrial

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2M20SE-5F484I	304	1.2V	-5	fpBGA	484	Ind	20
LFE2M20SE-6F484I	304	1.2V	-6	fpBGA	484	Ind	20
LFE2M20SE-5F256I	140	1.2V	-5	fpBGA	256	Ind	20
LFE2M20SE-6F256I	140	1.2V	-6	fpBGA	256	Ind	20

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2M35SE-5F672I	410	1.2V	-5	fpBGA	672	Ind	35
LFE2M35SE-6F672I	410	1.2V	-6	fpBGA	672	Ind	35
LFE2M35SE-5F484I	303	1.2V	-5	fpBGA	484	Ind	35
LFE2M35SE-6F484I	303	1.2V	-6	fpBGA	484	Ind	35
LFE2M35SE-5F256I	140	1.2V	-5	fpBGA	256	Ind	35
LFE2M35SE-6F256I	140	1.2V	-6	fpBGA	256	Ind	35

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2M50SE-5F900I	410	1.2V	-5	fpBGA	900	Ind	50
LFE2M50SE-6F900I	410	1.2V	-6	fpBGA	900	Ind	50
LFE2M50SE-5F672I	372	1.2V	-5	fpBGA	672	Ind	50
LFE2M50SE-6F672I	372	1.2V	-6	fpBGA	672	Ind	50
LFE2M50SE-5F484I	270	1.2V	-5	fpBGA	484	Ind	50
LFE2M50SE-6F484I	270	1.2V	-6	fpBGA	484	Ind	50

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2M70SE-5F1152I	436	1.2V	-5	fpBGA	1152	Ind	70
LFE2M70SE-6F1152I	436	1.2V	-6	fpBGA	1152	Ind	70
LFE2M70SE-5F900I	416	1.2V	-5	fpBGA	900	Ind	70
LFE2M70SE-6F900I	416	1.2V	-6	fpBGA	900	Ind	70

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2M100SE-5F1152I	520	1.2V	-5	fpBGA	1152	Ind	100
LFE2M100SE-6F1152I	520	1.2V	-6	fpBGA	1152	Ind	100
LFE2M100SE-5F900I	416	1.2V	-5	fpBGA	900	Ind	100
LFE2M100SE-6F900I	416	1.2V	-6	fpBGA	900	Ind	100



LatticeECP2/M Family Data Sheet

Revision History

September 2013

Data Sheet DS1006

Date	Version	Section	Change Summary
February 2006	01.0	—	Initial release.
August 2006	01.1	Introduction	
			Updated Table 1-1 "LatticeECP2 Family Selection Guide".
		Architecture	Updated Figure 2-2 "PFU Diagram".
			Updated Figure 2-13 "Secondary Clock Regions ECP2-50".
			Updated Figure 2-25 "PIC Diagram".
			Updated Figure 2-26 "Input Register Block for Left, Right and Bottom Edges".
			Updated Figure 2-28 "Output Register Block for Left, Right and Bottom Edges".
			Updated Figure 2-30 "DQS Input Routing for Left and Right Edges".
			Updated Figure 2-32 "Edge Clock, DLL Calibration and DQS Local Bus Distribution".
			Table 2-15 Selectable Master Clock (CCLK) Frequencies - Removed frequencies 15, 20, 21, 22, 23, 30, 34, 41, 45, 51, 55, 60.
			Replaced "CLKINDEL" with "CLKO".
			Updated SED section.
			Qualified device migration capability when using DQS banks for DDR interfaces.
		DC and Switching Characteristics	Added VCCPLL to the Recommended Operating Conditions table.
			Removed note 5 from "Hot Specifications" section.
			Added notes 7 and 8 to "Initialization Supply" Current table.
			Change note 6 - "...down to 95MHz" to "...down to 95MHz for DDR and 133MHz for DDR2" .
			New "Typical Building Block Function Performance" numbers.
			New External Switching Characteristics numbers.
			New Internal Switching Characteristics numbers.
			New Family Timing Adders numbers.
			Updated Timings for GPLLs, SPLLs and DLLs.
			Added sysCONFIG waveforms.
			Remove HSTL15D_II from sysIO Recommended Operating Conditions table.
			Updated Supply and Initialization Currents for ECP2-50.
		Pinout Information	Added VCCPLL to the Signal Descriptions table.
			Updated Logic Signal Connections tables to include 484-fpBGA for the ECP2-50.
			Added Logic Signal Connections tables for ECP2-12 devices.
			Updated Pin Information Summary table to include ECP2-12.
			Updated Power Supply and NC Connections table to include ECP2-12.
			Added note 2 to DDR Strobe (DQS) Pin table.
			Added Information on: PCI, DDR & SPI4.2 Capabilities of the device-Package combination.

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Date	Version	Section	Change Summary
June 2013 (cont.)	04.0 (cont.)	DC and Switching Characteristics	sysCLOCK SPLL Timing table – Corrected signal names for t_{RST} parameter.
			LatticeECP2/M sysCONFIG Port Timing Specifications table – added t_{SUMCDI} and t_{HMCDI} parameters.
September 2013	04.1	Architecture	Updated Selectable Master Clock (CCLK) Frequencies during Configuration table.
		DC and Switching Characteristics	Added information on f_{MAXSPI} parameter in LatticeECP2/M sys-CONFIG Port Timing Specifications table.